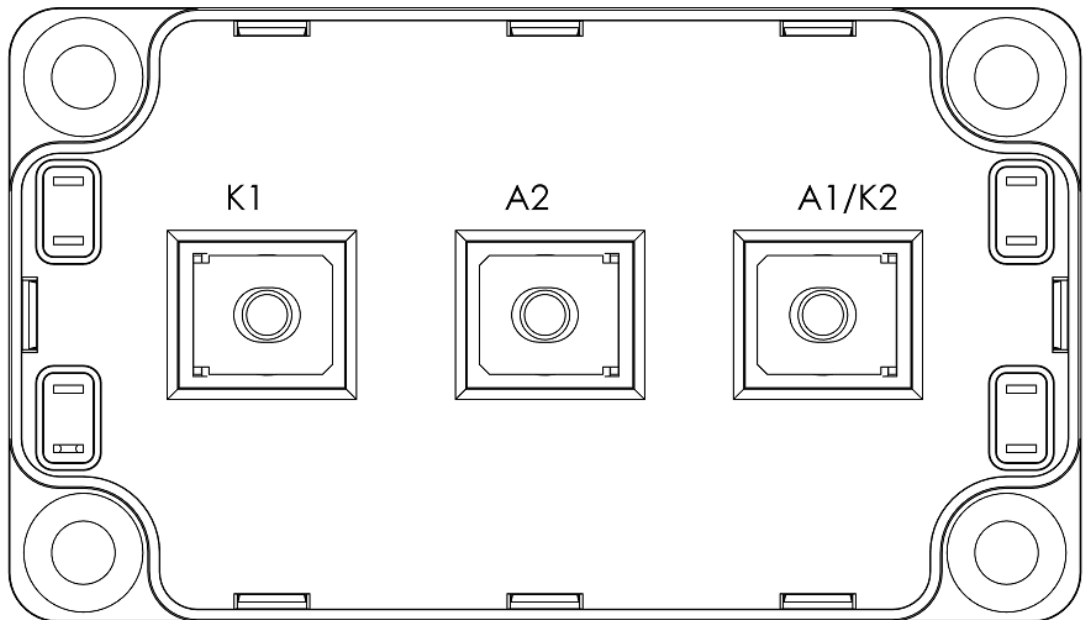
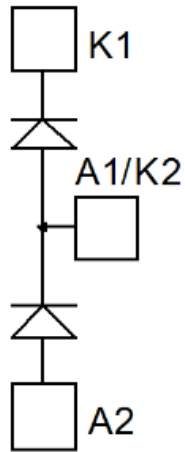


MSCDC600A70AG SiC Diode Phase Leg Power Module

1 Product Overview

This section provides the product overview for the MSCDC600A70AG device.



All ratings at $T_j = 25\text{ }^\circ\text{C}$, unless otherwise specified.

Caution: These devices are sensitive to electrostatic discharge. Proper handling procedures should be followed.

1.1 Features

The following are key features of the MSCDC600A70AG device:

- Silicon carbide (SiC) Schottky diode
 - Zero reverse recovery
 - Zero forward recovery
 - Temperature-independent switching behavior
 - Positive temperature coefficient on VF
- Low stray inductance
- M5 power connectors
- High level of integration
- Aluminum nitride (AlN) substrate for improved thermal performance

1.2 Benefits

The following are benefits of the MSCDC600A70AG device:

- Outstanding performance at high-frequency operation
- Low noise switching
- Direct mounting to heatsink (isolated package)
- Low junction-to-case thermal resistance
- RoHS compliant

1.3 Applications

The MSCDC600A70AG device is designed for the following applications:

- Uninterruptible power supply (UPS)
- Induction heating
- Welding equipment
- High-speed rectifiers

2 Electrical Specifications

This section provides the electrical specifications for the MSCDC600A70AG device.

2.1 Absolute Maximum Ratings

The following table shows the absolute maximum ratings per diode for the MSCDC600A70AG device.

Table 1 • Absolute Maximum Ratings

Symbol	Parameter	Maximum Ratings	Unit
V_{RRM}	Repetitive peak reverse voltage	700	V
I_F	DC forward current	$T_C = 45\text{ }^\circ\text{C}$ 600	A

The following table shows the thermal and package characteristics of the MSCDC600A70AG.

Table 2 • Thermal and Package Characteristics

Symbol	Characteristic	Min	Max	Unit		
V_{ISOL}	RMS isolation voltage, any terminal to case $t = 1$ minute, 50 Hz/60 Hz	4000		V		
T_J	Operating junction temperature range	-40	175	$^\circ\text{C}$		
T_{JOP}	Recommended junction temperature under switching conditions	-40	$T_{Jmax} - 25$			
T_{STG}	Storage temperature range	-40	125			
T_C	Operating case temperature	-40	125			
Torque	Mounting torque	To heatsink	M6	3	5	N.m
		For terminals	M5	2	3.5	
Wt	Package weight			300	g	

2.2 Electrical Performance

The following table shows the electrical characteristics per diode of the MSCDC600A70AG.

Table 3 • Electrical Characteristics Per Diode

Symbol	Characteristic	Test Conditions	Min	Typ	Max	Unit
V_F	Diode forward voltage	$I_F = 600\text{ A}$	$T_j = 25\text{ }^\circ\text{C}$	1.5	1.8	V
			$T_j = 175\text{ }^\circ\text{C}$	1.9		
I_{RM}	Reverse leakage current	$V_R = 700\text{ V}$	$T_j = 25\text{ }^\circ\text{C}$	0.18	2.4	mA
			$T_j = 175\text{ }^\circ\text{C}$	1.9		
Q_C	Total capacitive charge	$V_R = 400\text{ V}$		1596		nC
C	Total capacitance	$f = 1\text{ MHz}, V_R = 200\text{ V}$		2976		pF
			$f = 1\text{ MHz}, V_R = 400\text{ V}$	2592		
R_{thJC}	Junction-to-case thermal resistance				0.09	$^\circ\text{C/W}$

2.3 Performance Curves

This section shows the typical performance curves for the MSCDC600A70AG device.

Figure 1 • Maximum Transient Thermal Impedance

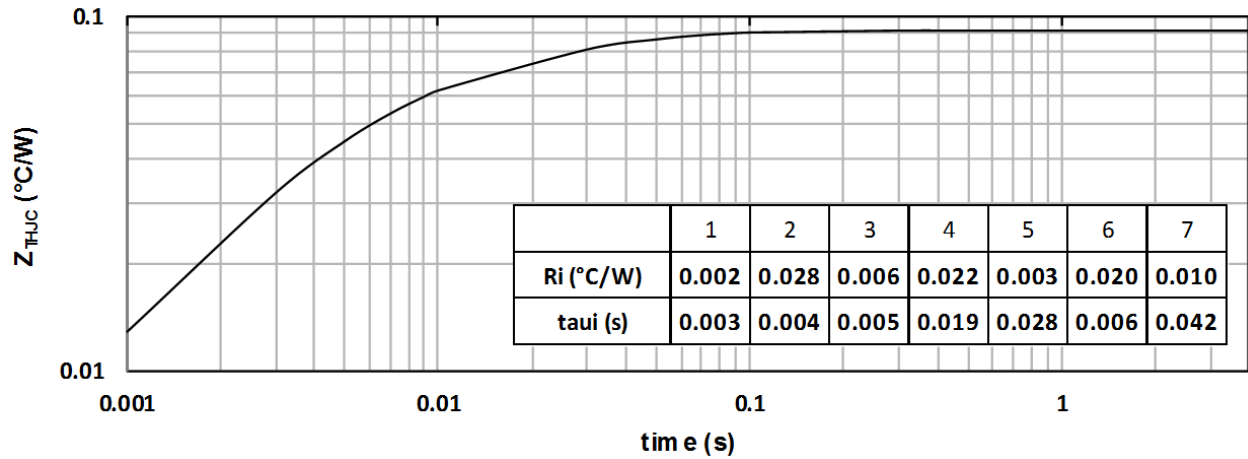


Figure 2 • Forward Current vs. Forward Voltage

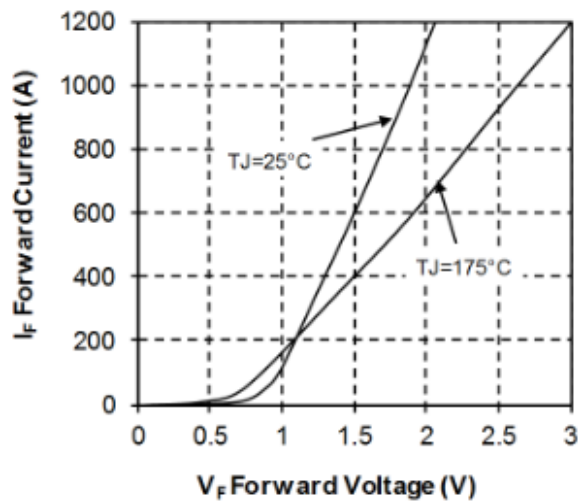


Figure 3 • Capacitance vs. Reverse Voltage

